

# MOS FIELD EFFECT TRANSISTOR $\mu$ PA1851

# P-CHANNEL MOS FIELD EFFECT TRANSISTOR FOR SWITCHING

## DESCRIPTION

The  $\mu$ PA1851 is a switching device which can be driven directly by a 4.0-V power source.

The  $\mu$ PA1851 features a low on-state resistance and excellent switching characteristics, and is suitable for applications such as power switch of portable machine and so on.

### FEATURES

- Can be driven by a 4.0-V power source
- Low on-state resistance  $R_{DS(on)1} = 105 \text{ m}\Omega \text{ MAX.}$  (VGs = -10 V, ID = -1.5 A)  $R_{DS(on)2} = 210 \text{ m}\Omega \text{ MAX.}$  (VGs = -4.5 V, ID = -1.5 A)  $R_{DS(on)3} = 250 \text{ m}\Omega \text{ MAX.}$  (VGs = -4.0 V, ID = -1.5 A)
- Built-in G-S protection diode against ESD

#### **ORDERING INFORMATION**

PART NUMBER	PACKAGE
μPA1851GR-9JG	Power TSSOP8

#### ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

Drain to Source Voltage	VDSS	-20
Gate to Source Voltage	Vgss	-20/+5
Drain Current (DC)	D(DC)	∓2.5
Drain Current (pulse) Note1	D(pulse)	<b>∓10</b>
Total Power Dissipation Note2	Рт	2.0
Channel Temperature	Tch	150
Storage Temperature	Tstg	–55 to +150

**Notes 1.** PW  $\leq$  10  $\mu$ s, Duty Cycle  $\leq$  1 %

- 2. Mounted on ceramic substrate of 50 cm<sup>2</sup> x 1.1 mm
- **Remark** The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

V

V

A A

W

°C °C

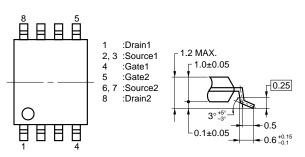
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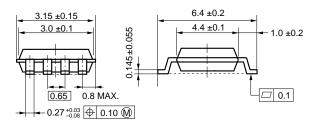
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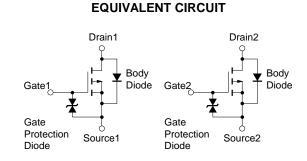
D12733EJ2V0DS00 (2nd edition) February 2000 NS CP(K) The mark  $\star$  shows major revised points.

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# PACKAGE DRAWING (Unit : mm)



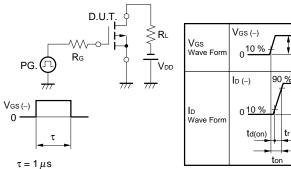




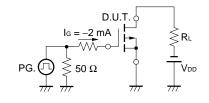
# ★ ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = 25 °C)

CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Drain Cut-off Current	IDSS	$V_{DS} = -20 V, V_{GS} = 0 V$			-10	μA
Gate Leakage Current	lgss	$V_{GS} = \mp 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			<b>∓ 10</b>	μA
Gate Cut-off Voltage	V <sub>GS(off)</sub>	$V_{DS} = -10 V$ , $I_D = -1 mA$	-1.0	-1.5	-2.5	V
Forward Transfer Admittance	y <sub>fs</sub>	$V_{DS} = -10 V$ , $I_D = -1.5 A$	1	3.5		S
Drain to Source On-state Resistance	RDS(on)1	$V_{GS} = -10 \text{ V}, \text{ ID} = -1.5 \text{ A}$		83	105	mΩ
	RDS(on)2	$V_{GS} = -4.5 \text{ V}, \text{ Id} = -1.5 \text{ A}$		141	210	mΩ
	RDS(on)3	$V_{GS} = -4.0 \text{ V}, \text{ Id} = -1.5 \text{ A}$		163	250	mΩ
Input Capacitance	Ciss	Vps = -10 V		220		pF
Output Capacitance	Coss	Vgs = 0 V		240		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		50		pF
Turn-on Delay Time	td(on)	$V_{DD} = -10 V$		110		ns
Rise Time	tr	ID = -2.0 A		500		ns
Turn-off Delay Time	td(off)	$V_{GS(on)} = -4.0 V$		160		ns
Fall Time	tr	Rg = 10 Ω		310		ns
Total Gate Charge	QG	$V_{DD} = -10 V$		8.3		nC
Gate to Source Charge	QGS	I⊳ = −2.5 A		2.4		nC
Gate to Drain Charge	Qgd	V <sub>GS</sub> = -4.0 V		4.7		nC
Diode Forward Voltage	VF(S-D)	IF = 2.5 A, VGS = 0 V		0.82		V
Reverse Recovery Time	trr	IF = 2.5 A, VGS = 0 V		40		ns
Reverse Recovery Charge	Qrr	di/dt = 20 A/ $\mu$ s		6.5		nC

## ★ TEST CIRCUIT 1 SWITCHING TIME



#### **TEST CIRCUIT 2 GATE CHARGE**



Duty Cycle  $\leq 1 \%$ 

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90 %

90 %

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10 %

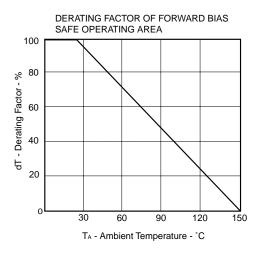
VGS(on)

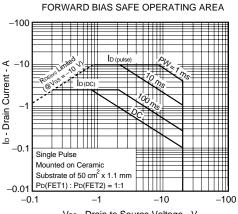
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td(off)

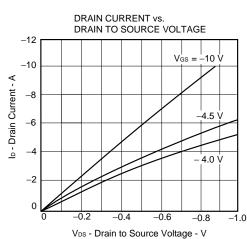
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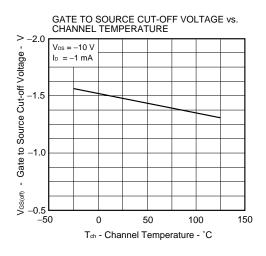
## ★ TYPICAL CHARACTERISTICS (T<sub>A</sub> = 25°C)



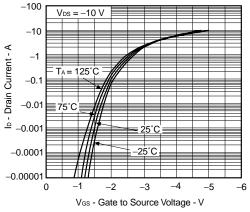




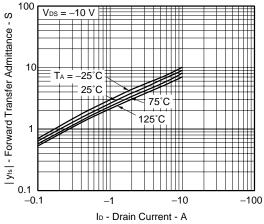




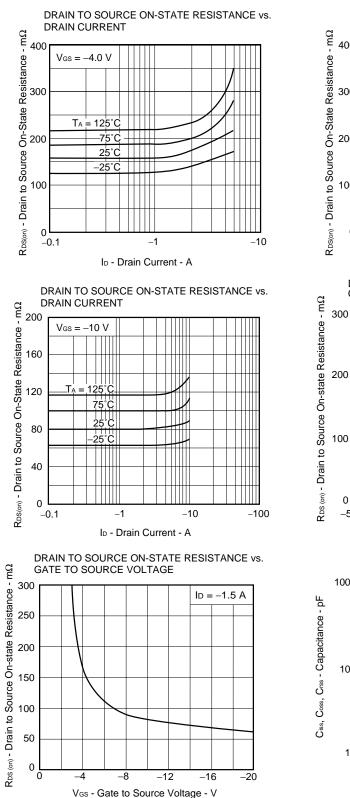
TRANSFER CHARACTERISTICS

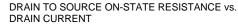


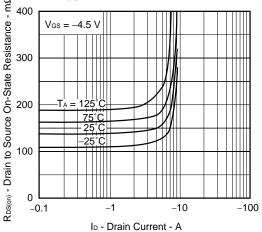
FORWARD TRANSFER ADMMITTANCE Vs. DRAIN CURRENT



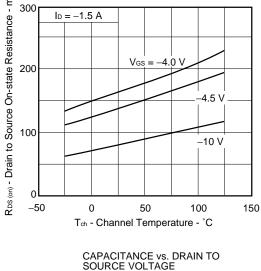
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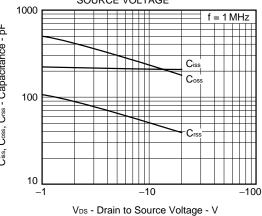






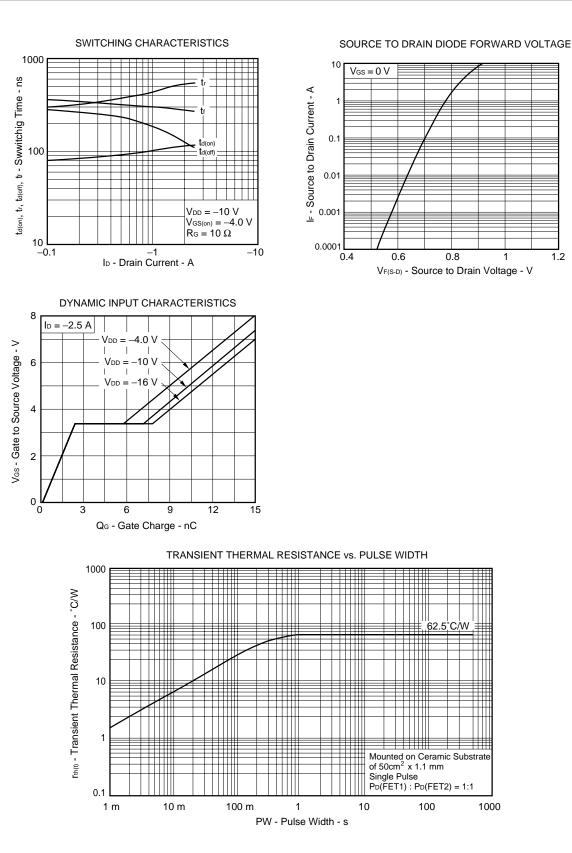
DRAIN TO SOURCE ON-STATE RESISTANCE vs. CHANNEL TEMPERATURE





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1.2



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